General Description

The 9VRS4339B is a Intel CK-NET compatible main clock for Intel Netbooks, conforming to the CK-NET specification. It is driven with a 25MHz crystal and generates a variety of clocks, including an LCD clock. An SMBus interface allows full control of the device.

Output Features

- 2 – 0.8V push-pull differential CPU pairs
- 5 – 0.8V push-pull differential SRC pairs
- 1 – 0.8V push-pull differential SATA pair
- 1 – 0.8V push-pull differential DOT96/SRC pair
- 1 – 0.8V push-pull differential LCD100 pair
- 1 – 0.8V push-pull differential CPU_ITP/SRC pair
- 2 – PCI (33MHz)
- 1 – PCI_F, (33MHz) free-running
- 1 – USB_48MHz
- 1 – 48MHz
- 1 – 25MHz
- 1 – 27MHz/PCI
- 1 – 14.318MHz

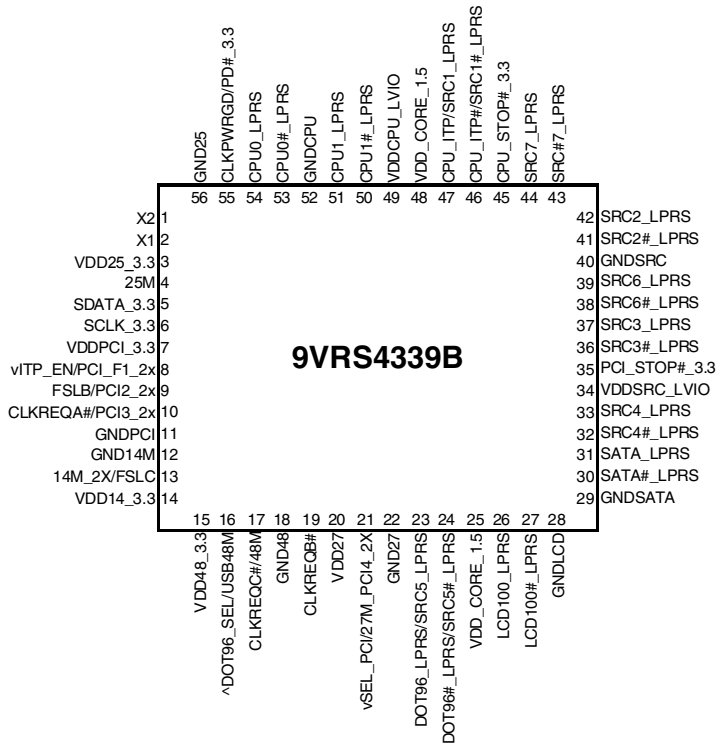
Features/Benefits

- Supports Wake_On_LAN (see pin55 pin description)
- Selectable spread % on CPU, SRC, PCI; Supports margining
- Uses external 25MHz crystal, external crystal load caps are required for frequency tuning
- CLKREQ# pins; Support SRC power management
- Low power differential clock outputs driving 100 ohm differential traces; reduced powe
- Integrated 33 ohm series resistors on all differential outputs; reduced board space

Key Specifications

- CPU outputs cycle-to-cycle jitter <85ps
- SRC cycle-to-cycle jitter <85ps
- SRC meets PCIEX Gen2 specifications
- SATA outputs cycle-to-cycle jitter <125ps
- PCI outputs cycle-to-cycle jitter <500ps
- ±100ppm frequency accuracy on all clocks

Pin Configuration



v prefix indicates internal pull-down resistor
^ prefix indicates internal pull-up resistor

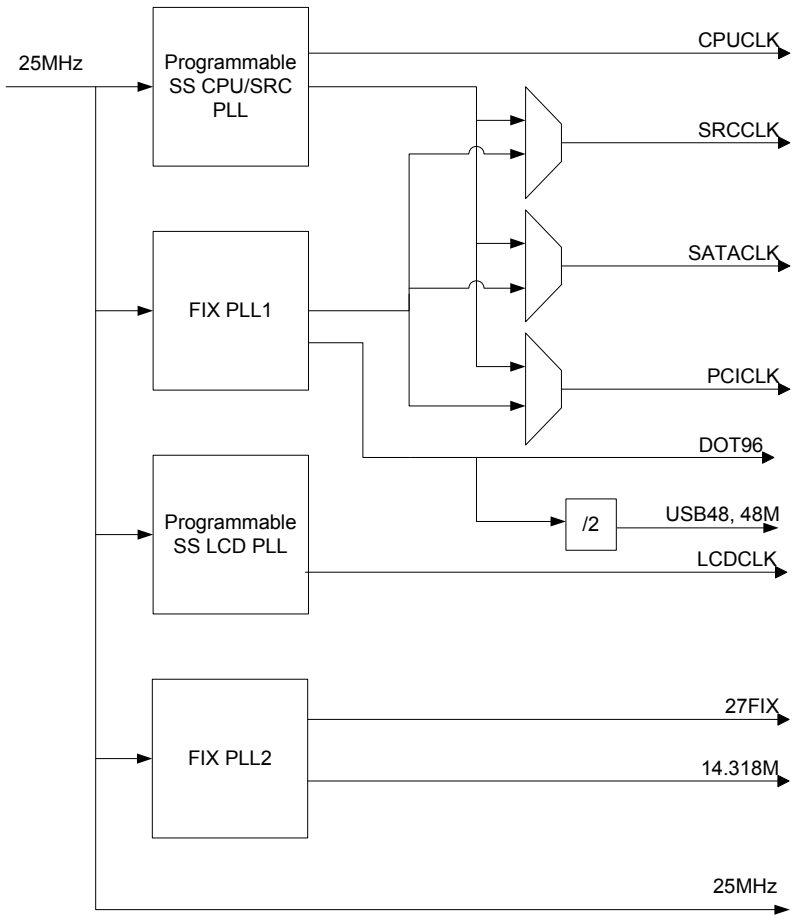
Pin Descriptions

PIN #	PIN NAME	TYPE	DESCRIPTION
1	X2	OUT	Crystal output, nominally 25MHz
2	X1	IN	Crystal input, nominally 25MHz
3	VDD25_3.3	PWR	Power pin for crystal and 25MHz output, nominal 3.3V
4	25M	OUT	3.3V 25MHz clock output
5	SDATA_3.3	I/O	Data pin for SMBus circuitry, 3.3V tolerant.
6	SCLK_3.3	OUT	Clock pin of SMBus circuitry, 3.3V tolerant.
7	VDDPCI_3.3	PWR	Power supply for PCI clocks, nominal 3.3V
8	vITP_EN/PCI_F1_2x	I/O	ITP enable latched input ITP_Enable Selects the functionality of the CPU_ITP/SRC output as follows: 1 = CPU_ITP output 0 = SRC1 output / Free-Running 3.3V PCI clock output, default to drive 2 loads.
9	FSLB/PCI2_2x	I/O	3.3V tolerant input for CPU frequency selection. Low voltage threshold inputs, see input electrical characteristics for Vil_FS and Vih_FS values / 3.3V PCI clock output, default to drive 2 loads.
10	CLKREQA#/PCI3_2x	I/O	3.3V real-time output enable for PCI Express (SRC) outputs. SMBus selects which outputs are controlled. Pin function is programmable through SMBus. See CLKREQ# Control Table and SRC Power Management Table for details 0 = controlled outputs are enabled 1 = controlled outputs are Low/Low / 3.3V PCI clock output, default to drive 2 loads. .
11	GNDPCI	PWR	Ground pin for the PCI outputs
12	GND14M	PWR	Ground pin for the 14.318MHz output
13	14M_2X/FSLC	I/O	3.3V 14.318 MHz clock output, default to drive 2 loads / 3.3V tolerant input for CPU frequency selection. Refer to input electrical characteristics for Vil_FS and Vih_FS values.
14	VDD14_3.3	PWR	Power pin for 14.318MHz output, nominal 3.3V
15	VDD48_3.3	PWR	Power pin for 48MHz outputs, nominal 3.3V
16	^DOT96_SEL/USB48M	I/O	Input latched pin to select Pin23/24 as DOT 96MHz clock or SRC clock 1 = DOT96 output 0 = SRC5 output / 3.3V 48MHz USB clock output.
17	CLKREQC#/48M	I/O	3.3V real-time output enable for PCI Express (SRC) outputs. SMBus selects which outputs are controlled. Pin function is programmable through SMBus. See CLKREQ# Control Table and SRC Power Management Table for details 0 = controlled outputs are enabled 1 = controlled outputs are Low/Low / 3.3V 48MHz clock output
18	GND48	PWR	Ground pin for 48MHz outputs
19	CLKREQB#	IN	3.3V real-time output enable for PCI Express (SRC) outputs. SMBus selects which outputs are controlled. 0 = controlled outputs are enabled 1 = controlled outputs are Low/Low
20	VDD27	PWR	Power pin for 27MHz output , nominal 3.3V
21	vSEL_PCI/27M_PCI4_2X	I/O	3.3V input latch pin to select this pin as 27M output or PCI4 clock output. This pin has an internal pulldown resistor. Latch functionality is as follows: 0 = 27MHz output 1 = 33.33MHz PCI output
22	GND27	PWR	Ground pin for the 27MHz output
23	DOT96_LPRS/SRC5_LPRS	OUT	True clock of push-pull DOT96 or SRC clock with integrated series resistor. No 50 ohm pull down needed. Default is pending on Pin16 DOT96_SEL.
24	DOT96#_LPRS/SRC5#_LPRS	OUT	Complement clock of push-pull DOT96 or SRC clock with integrated series resistor. No 50 ohm pull down needed. Default is pending on Pin16 DOT96_SEL.
25	VDD_CORE_1.5	PWR	Power pin for core PLL's, nominal 1.5V.
26	LCD100_LPRS	OUT	True clock of differential push-pull LCD100 output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
27	LCD100#_LPRS	OUT	Complementary clock of differential push-pull LCD100 output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
28	GNDLCD	PWR	Ground pin for LCD clock output

Pin Descriptions (cont.)

29	GNDSATA	PWR	Ground pin for the SATA outputs
30	SATA#_LPRS	OUT	Complementary clock of low power differential push-pull SATA clock pair with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
31	SATA_LPRS	OUT	True clock of low power differential push-pull SATA clock pair with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
32	SRC4#_LPRS	OUT	Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
33	SRC4_LPRS	OUT	True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
34	VDDSRC_LVIO	PWR	Power pin for SRC I/O, nominally 1.05V to 1.5V from external power supply
35	PCI_STOP#_3.3	IN	Stops all stoppable PCI, SATA and SRC clocks when low. Free-Running PCI, SATA and SRC clocks are not effected by this input. This input is 3.3V tolerant.
36	SRC3#_LPRS	OUT	Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
37	SRC3_LPRS	OUT	True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
38	SRC6#_LPRS	OUT	Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
39	SRC6_LPRS	OUT	True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
40	GNDSRC	PWR	Ground pin for the SRC outputs
41	SRC2#_LPRS	OUT	Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
42	SRC2_LPRS	OUT	True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
43	SRC#7_LPRS	OUT	Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
44	SRC7_LPRS	OUT	True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed.
45	CPU_STOP#_3.3	IN	Stops all stoppable CPU clocks when enabled. This is a 3.3V tolerant input.
46	CPU_ITP#/SRC1#_LPRS	OUT	Complementary clock of low power differential CPU_ITP/SRC pair with integrated 33ohm series resistor. No 50ohm resistor to GND needed. The pin function is determined by the latched value on ITP_EN: 0 = SRC1# 1 = CPU_ITP#
47	CPU_ITP/SRC1_LPRS	OUT	True clock of low power differential CPU_ITP/SRC pair with integrated 33ohm series resistor. No 50ohm resistor to GND needed. The pin function is determined by the latched value on ITP_EN: 0 = SRC1 1 = CPU_ITP
48	VDD_CORE_1.5	PWR	Power pin for core PLL, nominal 1.5V
49	VDDCPU_LVIO	PWR	Power pin for CPU I/O, nominally 1.05V to 1.5V from external power supply
50	CPU1#_LPRS	OUT	Complementary clock of differential pair 0.8V push-pull CPU output with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
51	CPU1_LPRS	OUT	True clock of differential pair 0.8V push-pull CPU output with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
52	GNDCPU	PWR	Ground pin for the CPU outputs
53	CPU0#_LPRS	OUT	Complementary clock of differential pair 0.8V push-pull CPU output with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
54	CPU0_LPRS	OUT	True clock of differential pair 0.8V push-pull CPU output with integrated 33ohm series resistor. No 50 ohm resistor to GND needed.
55	CLKPWRGD/PD#_3.3	IN	This 3.3V LVTTL input notifies device to sample latched inputs and start up on first high assertion or exit Power Down Mode on subsequent assertions. When WLAN enable in Byte13 bit 5 =1, device will enter Wake-On-LAN mode with 25MHz being free-running. 1 = Normal operation 0 = Power Down Mode or Wake-On-LAN mode Note: For lowest power saving during WOL mode, it is mandatory to connect 3.3V and 1.5V core VDD pins to standby power and suspend/remove VDDIO pins.
56	GND25	PWR	Ground pin for 25MHz

Block Diagram



Series Resistors for Single Ended Outputs

D.C.Drive Strength	Number of Loads to Drive	Match Point for N & P Voltage / Current (mA)	Number of Loads Actually Driven.		
			1 Load Rs =	2 Loads Rs=	3 Loads Rs =
	1	0.56 / 33 (17Ω)	33Ω [39Ω]	-	-
	2	0.92 / 66 (14Ω)	39Ω [43Ω]	22Ω [27Ω]	-

Notes:

1. Preferred drive strengths using CK505 clock sources. Transmission lines to load do not share series resistors.
2. Desktop/Mobile Platforms with Zo = 50/55 ohms use the first resistor value.
3. Systems with Zo = 60 ohms use the resistor values in brackets [ ].

Table 1: CPU/SRC PLL Spread Frequency Selection

CPU/SRC SS Select (B1b6)	SS1 (B1b5)	SS0 (B1b4)	FSLC (B0b7)	FSLB (B0b6)	SPREAD %	CPU MHz	SRC MHz	SATA MHz	PCI MHz
0	**0**	**0**	**0**	**0**	**-0.50%**	**133.33**	**100.00**	**100.00**	**33.33**
0	**0**	**0**	**0**	**1**	**-0.50%**	**166.67**	**100.00**	**100.00**	**33.33**
0	**0**	**0**	**1**	**0**	**-0.50%**	**100.00**	**100.00**	**100.00**	**33.33**
0	**0**	**0**	**1**	**1**	**-0.50%**	**200.00**	**100.00**	**100.00**	**33.33**
0	0	1	0	0	-0.40%	133.33	100.00	100.00	33.33
0	0	1	0	1	-0.40%	166.67	100.00	100.00	33.33
0	0	1	1	0	-0.40%	100.00	100.00	100.00	33.33
0	0	1	1	1	-0.40%	200.00	100.00	100.00	33.33
0	1	0	0	0	-0.30%	133.33	100.00	100.00	33.33
0	1	0	0	1	-0.30%	166.67	100.00	100.00	33.33
0	1	0	1	0	-0.30%	100.00	100.00	100.00	33.33
0	1	0	1	1	-0.30%	200.00	100.00	100.00	33.33
0	1	1	0	0	OFF	133.33	100.00	100.00	33.33
0	1	1	0	1	OFF	166.67	100.00	100.00	33.33
0	1	1	1	0	OFF	100.00	100.00	100.00	33.33
0	1	1	1	1	OFF	200.00	100.00	100.00	33.33
1	0	0	0	0	+/-0.25%	133.33	100.00	100.00	33.33
1	0	0	0	1	+/-0.25%	166.67	100.00	100.00	33.33
1	0	0	1	0	+/-0.25%	100.00	100.00	100.00	33.33
1	0	0	1	1	+/-0.25%	200.00	100.00	100.00	33.33
1	0	1	0	0	+/-0.20%	133.33	100.00	100.00	33.33
1	0	1	0	1	+/-0.20%	166.67	100.00	100.00	33.33
1	0	1	1	0	+/-0.20%	100.00	100.00	100.00	33.33
1	0	1	1	1	+/-0.20%	200.00	100.00	100.00	33.33
1	1	0	0	0	+/-0.15%	133.33	100.00	100.00	33.33
1	1	0	0	1	+/-0.15%	166.67	100.00	100.00	33.33
1	1	0	1	0	+/-0.15%	100.00	100.00	100.00	33.33
1	1	0	1	1	+/-0.15%	200.00	100.00	100.00	33.33
1	1	1	0	0	OFF	133.33	100.00	100.00	33.33
1	1	1	0	1	OFF	166.67	100.00	100.00	33.33
1	1	1	1	0	OFF	100.00	100.00	100.00	33.33
1	1	1	1	1	OFF	200.00	100.00	100.00	33.33

*** Bold is default**

Table 2: LCD Spread Selection Table

FS2	FS1	FS0	LCD SS	SPREAD	LCD100
0	1	0	0	-0.50%	100.00
0	1	1	0	-1.0%	100.00
1	0	0	0	-1.5%	100.00
1	0	1	0	-2.0%	100.00
1	**1**	**0**	**0**	**-2.50%**	**100.00**
0	1	0	1	+/-0.25%	100.00
0	1	1	1	+/-0.5%	100.00
1	0	0	1	+/-0.75%	100.00
1	0	1	1	+/-1.0%	100.00
1	1	0	1	+/-1.25%	100.00

*** Bold is default**

Power Distribution Table

Pin Number				Description
3.3V VDD	1.5V VDD	1.05-1.5V VDD	GND	
3	-	-	56	25MHz Crystal I/O; Internal Control Logic; 25MHz Output
7	-	-	11	PCICLK Outputs
14	-	-	12	14.318MHz & 27MHz outputs, 14/27MHz PLL Digital
15	-	-	18	48MHz output
20	-	-	22	27MHz output, 14/27MHz PLL analog
-	25	-	28, 29	DOT96 Fix PLL Analog & Digital, LCD100 PLL Analog & Digital
-	-	34	40	SRC Outputs
-	48	-	52	CPU/SRC PLL Analog & Digital
-	-	49	52	CPU Outputs

CPU Power Management Table

CLKPWRGD/PD#_3.3	SMBus Register OE	CPU_STOP#	CPU (0, 1, ITP)	
			True O/P	Comp. O/P
1	Enable	1	Running	Running
1	Enable	0	High	Low
0	X	X	Low/20K	Low
X	Disable	X	Low/20K	Low

DOT96 and SATA Power Management Table

CLKPWRGD/PD#_3.3	SMBus Register OE	PCI_STOP#	CLKREQC#	SATA PEREQC# Controlled		SATA PEREQC# Not-Controlled		DOT96	
				True O/P	Comp. O/P	True O/P	Comp. O/P	True O/P	Comp. O/P
1	Enable	1	0	Running	Running	Running	Running	Running	Running
1	Enable	1	1	Low/20K	Low	Running	Running	Running	Running
0	X	X	X	Low/20K	Low	Low/20K	Low	Low/20K	Low
X	Disable	X	X	Low/20K	Low	Low/20K	Low	Low/20K	Low

SRC Power Management Table

CLKPWRGD/PD#_3.3	SMBus Register OE	PCI_STOP#	CLKREQx#	SRC controlled by CLKREQx# Free-Running		SRC not controlled by CLKREQx# Free-Running		SRC controlled by CLKREQx# Stoppable		SRC not controlled by CLKREQx# Stoppable	
				True O/P	Comp. O/P	True O/P	Comp. O/P	True O/P	Comp. O/P	True O/P	Comp. O/P
1	Enable	1	0	Running	Running	Running	Running	Running	Running	Running	Running
1	Enable	1	1	Low/20K	Low	Running	Running	Low/20K	Low	Running	Running
1	Enable	0	0	Running	Running	Running	Running	High	Low	High	Low
1	Enable	0	1	Low/20K	Low	Running	Running	Low/20K	Low	High	Low
0	Enable	X	X	Low/20K	Low	Low/20K	Low	Low/20K	Low	Low/20K	Low
X	Disable	X	X	Low/20K	Low	Low/20K	Low	Low/20K	Low	Low/20K	Low

SIngle-ended Power Management Table

CLKPWRGD/PD#_3.3	SMBus Register OE	PCI_STOP#	PCI_F1, PCI2, PCI4		PCI3		25M		14.318M	USB48	48M	27MHz
			Free-run	Stoppable	Free-run	Stoppable	WOL Enabled	WOL Disabled				
1	Enable	1	Running	Running	Running	Running	Running	Running	Running	Running	Running	Running
1	Enable	0	Running	Low	Running	Low	Running	Running	Running	Running	Running	Running
0	Enable	X	Hi-Z	Hi-Z	Low	Low	Running	Low	Hi-Z	Hi-Z	Low	Hi-Z
0	Disable	X	Hi-Z	Hi-Z	Low	Low	Low	Low	Hi-Z	Hi-Z	Low	Hi-Z
1	Disable	X	Low	Low	Low	Low	Low	Low	Low	Low	Low	Low

CLKREQ# Control Table

CLKREQ#	SRC/SATA controlled
A	SRC1, 2, 3
B	SRC4, 6
C	SRC5, 7, SATA

General SMBus Serial Interface Information for 9VRS4339

How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- IDT clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- IDT clock will **acknowledge**
- Controller (host) sends the byte count = X
- IDT clock will **acknowledge**
- Controller (host) starts sending Byte **N through Byte N+X-1**
- IDT clock will **acknowledg**e each byte **one at a time**
- Controller (host) sends a Stop bit

Index Block Write Operation			
Controller (Host)			**IDT (Slave/Receiver)**
T	starT bit		
Slave Address			
WR	WRite		
			ACK
Beginning Byte = N			
			ACK
Data Byte Count = X			
			ACK
Beginning Byte N		X Byte	
			ACK
O			
O			O
O			O
			O
Byte N + X - 1			
			ACK
P	stoP bit		

Read Address	Write Address
$D3_{(H)}$	$D2_{(H)}$

How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- IDT clock will **acknowledge**
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will **acknowledge**
- IDT clock will send the data byte count = X
- IDT clock sends Byte **N+X-1**
- IDT clock sends **Byte 0 through Byte X (if $X_{(H)}$ was written to Byte 8)**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Read Operation			
Controller (Host)			**IDT (Slave/Receiver)**
T	starT bit		
Slave Address			
WR	WRite		
			ACK
Beginning Byte = N			
			ACK
RT	Repeat starT		
Slave Address			
RD	ReaD		
			ACK
			Data Byte Count=X
ACK			
		X Byte	Beginning Byte N
ACK			
			O
O			O
O			O
O			
			Byte N + X - 1
N	Not acknowledge		
P	stoP bit		

SMBus Table: Frequency Select, PD Config Source Select Register

Byte 0	Name	Control Function	Type	0	1	Default
Bit 7	FSLC	Freq Select Bit 1	RW	See Table 1: CPU/SRC PLL Frequency & Spread Selection Table		Latch
Bit 6	FSLB	Freq Select Bit 0	RW			Latch
Bit 5	CPU1 STOP EN	Enables Control of CPU1 with CPU_STOP	RW	Free-Running	Stoppable	0
Bit 4	CPU0 STOP EN	Enables Control of CPU0 with CPU_STOP	RW	Free-Running	Stoppable	0
Bit 3	PCI_SSEL	PCI Source Select	RW	CPU/SRC SS PLL	FIX PLL	0
Bit 2	SRC_SSEL	SRC Source Select	RW	CPU/SRC SS PLL	FIX PLL	0
Bit 1	SATA_SSEL	SATA Source Select	RW	CPU/SRC SS PLL	FIX PLL	0
Bit 0	PD Config	Forces "cold" start during PD	RW	Reset and Relatch	Normal PD# mode	1

SMBus Table: CPU, LCD SS and DOT96/SRC5 Control Register

Byte 1	Name	Control Function	Type	0	1	Default
Bit 7	DOT96_SEL	Selects DOT96 or SRC5	R	SRC5	DOT96	Latch
Bit 6	CPU/SRC SS Select	Selects Center or Down Spread for CPU & SRC	RW	Down Spread	Center Spread	0
Bit 5	CPU SS1	CPU SS Magnitude MSB	RW	See Table 1: CPU/SRC PLL Frequency & Spread Selection Table		0
Bit 4	CPU SS0	CPU SS Magnitude LSB	RW			0
Bit 3	LCD SS2	LCD SS Magnitude MSB	RW	See Table 2: LCDCLK Spread Spectrum Table		1
Bit 2	LCD SS1	LCD SS Magnitude	RW			1
Bit 1	LCD SS0	LCD SS Magnitude LSB	RW			0
Bit 0	LCD SS Select	Selects Center or Down Spread for LCDCLK	RW	Down Spread	Center Spread	0

SMBus Table: Output Enable Control Register

Byte 2	Name	Control Function	Type	0	1	Default
Bit 7	REF OE	Output Enable	RW	Disable	Enable	1
Bit 6	48M OE (Pin17)	Output Enable	RW	Disable	Enable	1
Bit 5	USB48M OE (Pin16)	Output Enable	RW	Disable	Enable	1
Bit 4	25M OE	Output Enable	RW	Disable	Enable	1
Bit 3	PCI3 OE	Output Enable	RW	Disable	Enable	1
Bit 2	PCI2 OE	Output Enable	RW	Disable	Enable	1
Bit 1	PCI_F1 OE	Output Enable	RW	Disable	Enable	1
Bit 0	CPU_ITP STOP EN	Enables Control of CPU_ITP with CPU_STOP	RW	Free-Running	Stoppable	0

SMBus Table: Output Enable Control Register

Byte 3	Name	Control Function	Type	0	1	Default
Bit 7	SRC7 OE	Output Enable	RW	Disable	Enable	1
Bit 6	SRC6 OE	Output Enable	RW	Disable	Enable	1
Bit 5	CLKREQC# Control	SRC5 is controlled	RW	Not Controlled	Controlled	0
Bit 4	CLKREQC# Control	SRC7 is controlled	RW	Not Controlled	Controlled	0
Bit 3	PCI4/27M OE	Output Enable	RW	Disable	Enable	1
Bit 2	LCDCLK OE	LCDPLL & Output Enable	RW	Disable	Enable	1
Bit 1	SRC4 OE	Output Enable	RW	Disable	Enable	1
Bit 0	SATA OE	Output Enable	RW	Disable	Enable	1

SMBus Table: Output Enable and SS Enable Control Register

Byte 4	Name	Control Function	Type	0	1	Default
Bit 7	SRC3 OE	Output Enable	RW	Disable	Enable	1
Bit 6	SRC2 OE	Output Enable	RW	Disable	Enable	1
Bit 5	CPU_ITP/SRC1 OE	Output Enable	RW	Disable	Enable	1
Bit 4	DOT96/SRC5 OE	Output Enable	RW	Disable	Enable	1
Bit 3	CPU1 OE	Output Enable	RW	Disable	Enable	1
Bit 2	CPU0 OE	Output Enable	RW	Disable	Enable	1
Bit 1	CPU/SRC PLL SS EN	Output Enable	RW	SS OFF	SS ON	1
Bit 0	CLKREQC# Control	SATA is controlled	RW	Not Controlled	Controlled	0

SMBus Table: CLKREQ Control Register

Byte 5	Name	Control Function	Type	0	1	Default
Bit 7	CLKREQA# EN	CLKREQA# Enable	RW	Disable	Enable	0
Bit 6	CLKREQA# Control	SRC1 is controlled	RW	Not Controlled	Controlled	0
Bit 5	CLKREQA# Control	SRC2 is controlled	RW	Not Controlled	Controlled	0
Bit 4	CLKREQA# Control	SRC3 is controlled	RW	Not Controlled	Controlled	0
Bit 3	CLKREQB# EN	CLKREQB# Enable	RW	Disable	Enable	0
Bit 2	CLKREQB# Control	SRC4 is controlled	RW	Not Controlled	Controlled	0
Bit 1	CLKREQB# Control	SRC6 is controlled	RW	Not Controlled	Controlled	0
Bit 0	CLKREQC# EN	CLKREQC# Enable	RW	Disable	Enable	0

Note: To enable CLKREQC function, please write "0" to Byte 9 bit 7 and "1" to Byte 5 bit 0. To select which output to control, please make necessay selection in Bytes 3 & 4.

Byte 6 Reserved Register

SMBus Table: Revision and Vendor ID Register

Byte 7	Name	Control Function	Type	0	1	Default
Bit 7	RID3	Revision ID	R	B rev = 0001		0
Bit 6	RID2		R			0
Bit 5	RID1		R			0
Bit 4	RID0		R			1
Bit 3	VID3	VENDOR ID	R	0001 = ICS/IDT		0
Bit 2	VID2		R			0
Bit 1	VID1		R			0
Bit 0	VID0		R			1

SMBus Table: Output Control Register

Byte 8	Name	Control Function	Type	0	1	Default
Bit 7	48M (Pin17) SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 6			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 5	27M / PCI4 SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 4			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 3	Reserved	Reserved	RW	-	-	0
Bit 2	PCI_SKEW_MODE	PCICLK Skew Mode Control	RW	PCI Aligned	PCI Delayed	0
Bit 1	LCD_AMP<1>	LCD Amplitude Control bit1	RW	00 = 700mV	01 = 800mV	0
Bit 0	LCD_AMP<0>	LCD Amplitude Control bit0	RW	10 = 900mV	11 = 1000mV	1

Note: A ssystem reset maybe required when switching between PCICLK aligned and skew mode

SMBus Table: Byte Count Register

Byte 9	Name	Control Function	Type	0	1	Default
Bit 7	48M_SEL	Selects 48M or CLKREQC	RW	CLKREQC	48M	1
Bit 6	Reserved	Reserved	RW	-	-	0
Bit 5	Reserved	Reserved	RW	-	-	0
Bit 4	BC4	Byte Count Programming	RW	Writing to this register will configure how many bytes will be read back, default is 0F or 1F = 15 bytes.		0
Bit 3	BC3		RW			1
Bit 2	BC2		RW			1
Bit 1	BC1		RW			1
Bit 0	BC0		RW			1

Note: To enable CLKREQC function, please write "0" to Byte 9 bit 7 and "1" to Byte 5 bit 0. To select which output to control, please make necessay selection in Bytes 3 & 4.

SMBus Table: Output Control Register

Byte 10	Name	Control Function	Type	0	1	Default
Bit 7	USB48M (Pin16) SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 6			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 5	REF SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 4			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 3	PCI3 SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 2			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 1	25M SR	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 0			RW	10 = 2.6V/ns	11 = 3.3V/ns	0

SMBus Table: Output Control Register

Byte 11	Name	Control Function	Type	0	1	Default
Bit 7	CPU	Differential Slew Rate	RW	0=2.5V/ns	1=4V/ns	1
Bit 6	SRC	Differential Slew Rate	RW	0=2.5V/ns	1=4V/ns	1
Bit 5	SATA	Differential Slew Rate	RW	0=2.5V/ns	1=4V/ns	1
Bit 4	DOT96	Differential Slew Rate	RW	0=2.5V/ns	1=4V/ns	1
Bit 3	PCI2	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 2			RW	10 = 2.6V/ns	11 = 3.3V/ns	0
Bit 1	PCI1	Slew Rate Control	RW	00 = 1.5V/ns	01 = 2.0V/ns	0
Bit 0			RW	10 = 2.6V/ns	11 = 3.3V/ns	0

SMBus Table: M/N Enable & Output Stop Control Register

Byte 12	Name	Control Function	Type	0	1	Default
Bit 7	CPU/SRC PLL M/N En	Enables M/N programming for CPU/SRC PLL	RW	Disable	Enable	0
Bit 6	SRC1 STOP EN	Enables Control of SRC1 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 5	SRC2 STOP EN	Enables Control of SRC2 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 4	SRC3 STOP EN	Enables Control of SRC3 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 3	SRC4 STOP EN	Enables Control of SRC4 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 2	SRC5 STOP EN	Enables Control of SRC5 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 1	SRC6 STOP EN	Enables Control of SRC6 with PCI_STOP	RW	Free-Running	Stoppable	0
Bit 0	SRC7 STOP EN	Enables Control of SRC7 with PCI_STOP	RW	Free-Running	Stoppable	0

SMBus Table: Output Control Register

Byte 13	Name	Control Function	Type	0	1	Default
Bit 7	ITP_EN	ITP_EN readback	R	SRC1	CPU_ITP	Latch
Bit 6	SEL_PCI	Select PCI Readback	R	27M	PCI4	Latch
Bit 5	WOL Enable	WOL Enable for 25M	RW	WOL Disabled	WOL Enabled	1
Bit 4	PCI_F1	Free Running with PCI_STOP#	RW	Free-Running	Stoppable	0
Bit 3	PCI2	Free Running with PCI_STOP#	RW	Free-Running	Stoppable	1
Bit 2	PCI3	Free Running with PCI_STOP#	RW	Free-Running	Stoppable	1
Bit 1	PCI4	Free Running with PCI_STOP#	RW	Free-Running	Stoppable	1
Bit 0	SATA STOP EN	Enables Control of SATA with PCI_STOP	RW	Free-Running	Stoppable	0

*** For lowest power saving during WOL mode, it is mandatory to connect 3.3V and 1.5V core VDD pins to standby power and suspend/remove VDDIO pins.**

SMBus Table: Differential Output Amplitude Control Register

Byte 14	Name	Control Function	Type	0	1	Default
Bit 7	PCIEX_AMP<1>	PCIEX Amplitude Control bit1	RW	00 = 700mV	01 = 800mV	0
Bit 6	PCIEX_AMP<0>	PCIEX Amplitude Control bit0	RW	10 = 900mV	11 = 1000mV	1
Bit 5	DOT96_AMP<1>	DOT96 Amplitude Control bit1	RW	00 = 700mV	01 = 800mV	0
Bit 4	DOT96_AMP<0>	DOT96 Amplitude Control bit0	RW	10 = 900mV	11 = 1000mV	1
Bit 3	SATA_AMP<1>	SATA Amplitude Control bit1	RW	00 = 700mV	01 = 800mV	0
Bit 2	SATA_AMP<0>	SATA Amplitude Control bit0	RW	10 = 900mV	11 = 1000mV	1
Bit 1	CPU_AMP<1>	CPUCLK Amplitude Control bit1	RW	00 = 700mV	01 = 800mV	0
Bit 0	CPU_AMP<0>	CPUCLK Amplitude Control bit0	RW	10 = 900mV	11 = 1000mV	1

Bytes 15+ Reserved Registers

****

All reserved bits and reserved bytes in this SMBus table should not be overwritten at any instance. Writing to these reserved bits and bytes may cause unexpected behavior. IDT does not warrant any application issue going forward if continuing to overwrite these reserve bits and bytes.

Absolute Maximum Ratings–DC Parameters

Stresses above the ratings listed below can cause permanent damage to the 9VRS4339B. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	Notes
Maximum Supply Voltage	VDD27, VDD_3.3	Supply Voltage		4.6	V	1,4
Maximum Supply Voltage	VDD_CORE_1.5	Supply Voltage		1.9	V	1,4
Maximum Supply Voltage	VDD_LVIO	Supply Voltage		1.9	V	1,4
Maximum Input Voltage	V_{IH}	3.3V Inputs, including SMBus		4.6	V	1,2,4
Minimum Input Voltage	V_{IL}	Any Input	GND - 0.5		V	1,4
Storage Temperature	Ts	-	-65	150	°C	4
Case Temperature	Tcase	-		115	°C	1
Input ESD protection	ESD prot	Human Body Model	2000		V	3,4

NOTES on DC Parameters: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

[1] Intentionally blank

[2] Maximum VIH is not to exceed VDD

[3] Human Body Model

[4] Operation under these conditions is neither implied, nor guaranteed.

Electrical Characteristics–PCICLK/PCICLK_F

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
Long Accuracy	ppm	see Tperiod min-max values	-100	100	ppm	1,2
Clock period	T_{period}	33.33MHz output no spread	29.99700	30.00300	ns	1,2,5
		33.33MHz output spread	30.08421	30.23459	ns	1,2,5
Absolute min/max period	T_{abs}	33.33MHz output no spread	29.49700	30.50300	ns	1,2
		33.33MHz output nominal/spread	29.56617	30.58421	ns	1,2
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4		V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA		0.4	V	1
Output High Current	I_{OH}	V_{OH}@MIN = 1.0 V	-33		mA	1
		V_{OH}@MAX = 3.135 V		-33	mA	1
Output Low Current	I_{OL}	V_{OL}@ MIN = 1.95 V	30		mA	1
		V_{OL} @ MAX = 0.4 V		38	mA	1
Rising Edge Slew Rate	t_{SLR}	Measured from 0.8 to 2.0 V	1	4	V/ns	1,3
Falling Edge Slew Rate	t_{FLR}	Measured from 2.0 to 0.8 V	1	4	V/ns	1,3
Duty Cycle	d_{t1}	V_T = 1.5 V	45	55	%	1,4
Adjacent Pin to Pin Skew	t_{skew}	V_T = 1.5 V, PCI Aligned Mode (Default)		250	ps	1,4,7
Adjacent Pin to Pin Intentional Delay	t_{skew_delay}	V_T = 1.5 V, PCI Delayed Mode	200ps typical		ps	1,4,8
Total PCI Skew Window	t_{skew_total}	V_T = 1.5 V , PCI Delayed Mode		800	ps	1,4,9
Jitter, Cycle to cycle	$t_{cyc-cyc}$	V_T = 1.5 V		500	ps	1,4

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, Rs=39ohm, CL=5pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3] Edge rate in system is measured from 0.8V to 2.0V.

[4] Duty cycle, Peroid, Skew and Jitter are measured with respect to 1.5V

[5] The average period over any 1us period of time

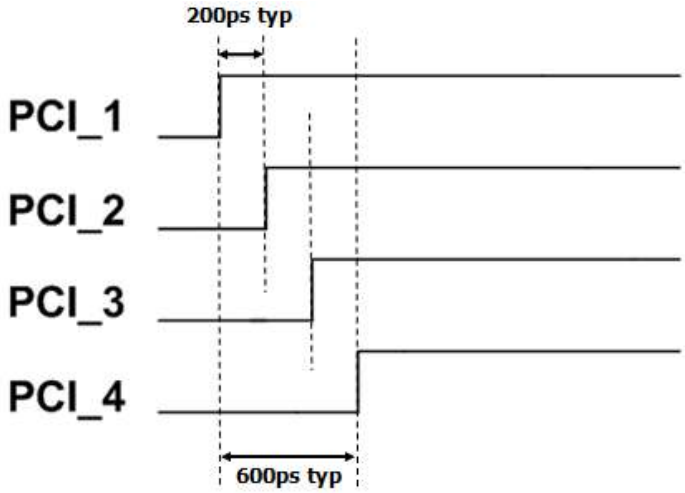
[6] Using frequency counter with the measurment interval equal or greater that 0.15s. Target frequencies are 14.318181 MHz, 25.000000MHz, 33.333333MHz, 27.000000MHz and 48.000000MHz

[7] Adjacent pin to pin skew is the pin to pin skew between PCI1 and PCI2, PCI2 and PCI3, or PCI3 to PCI4.

[8] Adjacent pin to pin intentional delay is the intentional delay between PCI1 and PCI2, PCI2 and PCI3, or PCI3 to PCI4.

[9] Total PCI skew winodw is absolute skew between PCI1 and PCI4.

PCICLK Relationship Timing Diagram During Delayed Mode



Electrical Characteristics–Input/Supply/Common Output DC Parameters

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	Notes
Ambient Operating Temp	Tambient	-	0	70	°C	
Supply Voltage	VDD27, VDD_3.3	Supply Voltage	3.135	3.465	V	
	VDD_CORE_1.5	Supply Voltage	1.425	1.575	V	
	VDD_LVIO	Supply Voltage	0.9975	1.575	V	
Input High Voltage	V_{IHSE}	Single-ended 3.3V inputs	2	V_{DD} + 0.3	V	3
Input Low Voltage	V_{ILSE}	Single-ended 3.3V inputs	V_{SS} - 0.3	0.8	V	3
Latched Input High Voltage	V_{IH_LI}	Single-ended 3.3V Latched Inputs	2	VDD + 0.3	V	
Latched Input Low Voltage	V_{IL_LI}	Single-ended 3.3V Latched Inputs	V_{SS} - 0.3	0.8	V	
Low Threshold Latched Input-High Voltage	V_{IH_FS}	Low threshold inputs FSL[C:B]	0.7	VDD+0.3	V	
Low Threshold Latched Input-Low Voltage	V_{IL_FS}	Low threshold inputs FSL[C:B]	V_{SS} - 0.3	0.35	V	
Input Leakage Current	I_{IN}	$V_{IN} = V_{DD}$, V_{IN} = GND	-5	5	uA	2
Input Leakage Current	I_{INRES}	Inputs with pull up or pull down resistors $V_{IN} = V_{DD}$, V_{IN} = GND	-200	200	uA	
Output High Voltage	V_{OHSE}	Single-ended outputs, I_{OH} = -1mA	2.4		V	1
Output Low Voltage	V_{OLSE}	Single-ended outputs, I_{OL} = 1 mA		0.4	V	1
Operating Supply Current	$I_{DDOP3.3}$	Full Active, C_L = Full load; IDD 3.3V		38	mA	
	$I_{DDOP1.5}$	Full Active, C_L = Full load; IDD 1.5V		40	mA	
	$I_{DDOP1.05}$	Full Active, C_L = Full load; IDD LVIO		46	mA	
Powerdown Current	$I_{DDPD3.3}$	Power down mode, 3.3V Rail		1.2	mA	5
	$I_{DDPD1.5}$	Power down mode, 1.5V Rail		1	mA	5
	$I_{DDPDLVIO}$	Power down mode, 1.05V Rail		0	mA	5
Wake-On-Lan Current	$I_{DDWOL3.3}$	Wake On LAN mode, 3.3V Rail		10	mA	6
	$I_{DDWOL1.5}$	Wake On LAN mode, 1.5V Rail		1	mA	6
	$I_{DDWOLLVIO}$	Wake On LAN mode, LVIO Rail		0	mA	6
Input Frequency	F_i	V_{DD} = 3.3 V	25MHz Typical		MHz	4
Pin Inductance	L_{pin}			7	nH	
Input Capacitance	C_{IN}	Logic Inputs	1.5	5	pF	
	C_{OUT}	Output pin capacitance		6	pF	
	C_{INX}	X1 & X2 pins		6	pF	
Clk Stabilization	T_{STAB}	From VDD Power-Up or de-assertion of PD to 1st clock		1.8	ms	
Tstop_CR_off	T_{CROFF}	Output stop after CLKREQ# deasserted	2	3	Clocks	
Trun_CR_on	T_{CRON}	Output run after CLKREQ# asserted	2	3	Clocks	
Tstop	T_{STOP}	CPU or PCI stop after CPU or PCI STOP# assertion	2	3	Clocks	
Trun	T_{RUN}	CPU or PCI run after CPU or PCI STOP# de-assertion	2	3	Clocks	
Tfall_SE	T_{FALL}	Fall/rise time of all 3.3V control inputs from 20-80%		10	ns	
Trise_SE	T_{RISE}			10	ns	
SMBus Voltage	V_{DD}		2.7	3.3	V	
Low-level Output Voltage	V_{OLSMB}	@ I_{PULLUP}		0.4	V	
Current sinking at V_{OLSMB} = 0.4 V	I_{PULLUP}	SMB Data Pin	4		mA	
SCLK/SDATA Clock/Data Rise Time	T_{RI2C}	(Max VIL - 0.15) to (Min VIH + 0.15)		1000	ns	
SCLK/SDATA Clock/Data Fall Time	T_{FI2C}	(Min VIH + 0.15) to (Max VIL - 0.15)		300	ns	
Maximum SMBus Operating Frequency	F_{SMBUS}			100	kHz	
Spread Spectrum Modulation Frequency	f_{SSMOD}	Triangular Modulation	30	33	kHz	

NOTES on DC Parameters: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

[1] Signal is required to be monotonic in this region.

[2] input leakage current does not include inputs with pull-up or pull-down resistors

[3] 3.3V referenced inputs are: PCI_STOP#, CPU_STOP#, ITP_EN, SCLK, SDATA, CLKPWRGD/PD#, DOT96_SEL, SEL_PCI, 48M_SEL and PEREQ# inputs if selected.

[4] For margining purposes only. Normal operation should have Fin = 25MHz +/-50ppm

[5] Standard powerdown with Wake on LAN disabled.

[6] Powerdown with Wake on LAN enabled

AC Electrical Characteristics–CPU, SRC, SATA, DOT96MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
Rising Edge Slew Rate	tSLR	Differential Measurement	2.5	4	V/ns	1,3
Falling Edge Slew Rate	tFLR	Differential Measurement	2.5	4	V/ns	1,3
Slew Rate Variation	tSLVAR	Single-ended Measurement		20	%	1,3
Maximum Output Voltage	VHIGH	Includes overshoot		1150	mV	1
Minimum Output Voltage	VLOW	Includes undershoot	-300		mV	1
Differential Voltage Swing	VSWING	Differential Measurement	300		mV	1
Crossing Point Voltage	VXABS	Single-ended Measurement	300	550	mV	1,3,4
Crossing Point Variation	VXABSVAR	Single-ended Measurement		140	mV	1,3,5
Duty Cycle	DCYC	Differential Measurement	45	55	%	1
CPU Jitter - Cycle to Cycle	CPUJC2C	Differential Measurement		85	ps	1
SRC Jitter - Cycle to Cycle	SRCJC2C	Differential Measurement		85	ps	1
SATA Jitter - Cycle to Cycle	SATAJC2C	Differential Measurement		125	ps	1
DOT Jitter - Cycle to Cycle	DOTJC2C	Differential Measurement		250	ps	1
CPU[1:0] Skew	CPU10SKEW	Differential Measurement		100	ps	1,6
CPU[ITP:0] Skew	CPU20SKEW	Differential Measurement		150	ps	1,6
PCIEX(6, 4:2) Skew	PCIEXSKEW	Differential Measurement		250	ps	1
PCIEX(7:1) Skew	PCIEXSKEW	Differential Measurement		500	ps	1

Notes: T_A = 0 - 70°C; V_{DD} = 3.3 V +/-5%; C_L=2pF, Rs=0Ω (unless specified otherwise)

[1] Guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3] Slew rate emastured through V_swing voltage range centered about differential zero

[4] Vcross is defined at the voltage where Clock = Clock#.

[5] Only applies to the differential rising edge (Clock rising, Clock# falling.)

[6] CPU group skew is nominally 0ps.

Electrical Characteristics–USB48MHz/48MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
Long Accuracy	ppm	see Tperiod min-max values	-100	100	ppm	1,2
Clock period	T_{period}	48.00MHz output nominal	20.83125	20.83542	ns	1,2,5
Absolute min/max period	T_{abs}	48.00MHz output nominal	20.48125	21.18542	ns	1,2
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4		V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA		0.4	V	1
Output High Current	I_{OH}	V_{OH}@MIN = 1.0 V	-29		mA	1
		V_{OH}@MAX = 3.135 V		-23	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	29		mA	1
		V_{OL} @ MAX = 0.4 V		27	mA	1
Rising Edge Slew Rate (USB48M)	t_{SLR}	Measured from 0.8 to 2.0 V	1	2	V/ns	1,3
Falling Edge Slew Rate (USB48M)	t_{FLR}	Measured from 2.0 to 0.8 V	1	2	V/ns	1,3
Rising Edge Slew Rate (48M)	t_{SLR}	Measured from 0.8 to 2.0 V	1	4	V/ns	1,3
Falling Edge Slew Rate (48M)	t_{FLR}	Measured from 2.0 to 0.8 V	1	4	V/ns	1,3
Duty Cycle	d_{t1}	V_T = 1.5 V	45	55	%	1,4
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	V_T = 1.5 V		350	ps	1,4

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, Rs=39ohm, CL=5pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3] Edge rate in system is measured from 0.8V to 2.0V.

[4] Duty cycle, Peroid and Jitter are measured with respect to 1.5V

[5] The average period over any 1us period of time

[6] Using frequency counter with the measurment interval equal or greater that 0.15s. Target frequencies are 14.318181 MHz, 25.000000MHz, 33.333333MHz, 27.000000MHz and 48.000000MHz

Electrical Characteristics–25MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
Long Accuracy	ppm	see Tperiod min-max values	-30	30	ppm	1,2
Clock period	T_{period}	25.00MHz output nominal	39.99880	40.00120	ns	1,2,5
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4		V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA		0.4	V	1
Output High Current	I_{OH}	V_{OH}@MIN = 1.0 V	-29		mA	1
		V_{OH}@MAX = 3.135 V		-23	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	29		mA	1
		V_{OL} @ MAX = 0.4 V		27	mA	1
Rising Edge Slew Rate	t_{SLR}	Measured from 0.8 to 2.0 V	0.5	2	V/ns	1,3
Falling Edge Slew Rate	t_{FLR}	Measured from 2.0 to 0.8 V	0.5	2	V/ns	1,3
Duty Cycle	d_{t1}	V_T = 1.5 V	45	55	%	1,4
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	V_T = 1.5 V		200	ps	1,4

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, Rs=39ohm, CL=5pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3] Edge rate in system is measured from 0.8V to 2.0V.

[4] Duty cycle, Peroid and Jitter are measured with respect to 1.5V

[5] The average period over any 1us period of time

[6] Using frequency counter with the measurment interval equal or greater that 0.15s. Target frequencies are 14.318181 MHz, 25.000000MHz, 33.333333MHz, 27.000000MHz and 48.000000MHz

Electrical Characteristics–REF-14.318MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-100	100	ppm	1,2
Clock period	Tperiod	14.318MHz output nominal	69.82033	69.86224	ns	1,2,5
Absolute min/max period	Tabs	14.318MHz output nominal	69.83400	70.84800	ns	1,2
Output High Voltage	V_{OH}	IOH = -1 mA	2.4		V	1
Output Low Voltage	V_{OL}	IOL = 1 mA		0.4	V	1
Output High Current	I_{OH}	V_{OH}@MIN = 1.0 V	-29		mA	1
		V_{OH}@MAX = 3.135 V		-23	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	29		mA	1
		V_{OL} @ MAX = 0.4 V		27	mA	1
Rising Edge Slew Rate	t_{SLR}	Measured from 0.8 to 2.0 V	1	4	V/ns	1,3
Falling Edge Slew Rate	t_{FLR}	Measured from 2.0 to 0.8 V	1	4	V/ns	1,3
Duty Cycle	d_{t1}	VT = 1.5 V	45	55	%	1,4
Jitter, Cycle to cycle	$t_{jcyc-cyc}$	VT = 1.5 V		1000	ps	1,4

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, Rs=39ohm, CL=5pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3] Edge rate in system is measured from 0.8V to 2.0V.

[4] Duty cycle, Peroid and Jitter are measured with respect to 1.5V

[5] The average period over any 1us period of time

[6] Using frequency counter with the measurment interval equal or greater that 0.15s. Target frequencies are 14.318181 MHz, 25.000000MHz, 33.333333MHz, 27.000000MHz and 48.000000MHz

Electrical Characteristics–27MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-50	50	ppm	1,2
			-15	15	ppm	1,2,7
Clock period	T_{period}	27.000MHz output nominal	37.0365	37.0376	ns	1,4,5
Output High Voltage	V_{OH}	I_{OH} = -1 mA	2.4		V	1
Output Low Voltage	V_{OL}	I_{OL} = 1 mA		0.4	V	1
Output High Current	I_{OH}	V_{OH}@MIN = 1.0 V	-29		mA	1
		V_{OH}@MAX = 3.135 V		-23	mA	1
Output Low Current	I_{OL}	V_{OL} @ MIN = 1.95 V	29		mA	1
		V_{OL} @ MAX = 0.4 V		27	mA	1
Rising Edge Slew Rate	t_{SLR}	Measured from 0.8 to 2.0 V	1	4	V/ns	1,3
Falling Edge Slew Rate	t_{FLR}	Measured from 2.0 to 0.8 V	1	4	V/ns	1,3
Duty Cycle	d_{t1}	V_T = 1.5 V	45	55	%	1,4
Jitter	t_{lj}	Long Term (10us), , V_T = 1.5 V		400	ps	1,4
	$t_{cyc-cyc}$	Cycle to Cycle, V_T = 1.5 V		200	ps	1,4

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, Rs = 39ohm, CL = 5pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2] All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 25.000000MHz

[3]Edge rate in system is measured from 0.8V to 2.0V.

[4] Duty cycle, Peroid and Jitter are measured with respect to 1.5V

[5] The average period over any 1us period of time

[6] Using frequency counter with the measurment interval equal or greater that 0.15s. Target frequencies are 14.318181 MHz, 25.000000MHz, 33.333333MHz, 27.000000MHz and 48.000000MHz

[7] At nominal voltage and temperature.

Clock Jitter Specifications - Low Power Differential Outputs

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
PCIEX Phase Jitter	$t_{jphasePLL}$	PCIe Gen 1		86	ps (p-p)	1,2
	$t_{jphaseLo}$	PCIe Gen 2 10kHz < f < 1.5MHz		3.0	ps (RMS)	1,3,4
	$t_{jphaseHigh}$	PCIe Gen 2 1.5MHz < f < Nyquist (50MHz)		3.1	ps (RMS)	1,3,4

*TA = 0 - 70°C; Supply Voltage VDD = 1.5V +/- 5%, Rs=0ohm, CL=2pF

[1] Unless otherwise noted, guaranteed by design and characterization, not 100% tested in production.

[2]JItter specs are specified as measured on a clock characterization board. System designers need to take special care not to use these numbers, as the in-system

[3] Phase jitter requirement: The designated Gen2 outputs will meet the reference clock jitter requiremernts from the PCI Express Gen2 Base Spec. The test is performed

[4]See http://www.pcisig.com for complete specs

Differential Clock Tolerances

	CPU	SRC	DOT96	SATA	
PPM tolerance	100	100	100	100	ppm
Cycle to Cycle Jitter	85	85	250	125	ps
Spread	-0.50%	-0.50%	0.00%	-0.50%	%

Clock Periods–Differential Outputs with Spread Spectrum Disabled

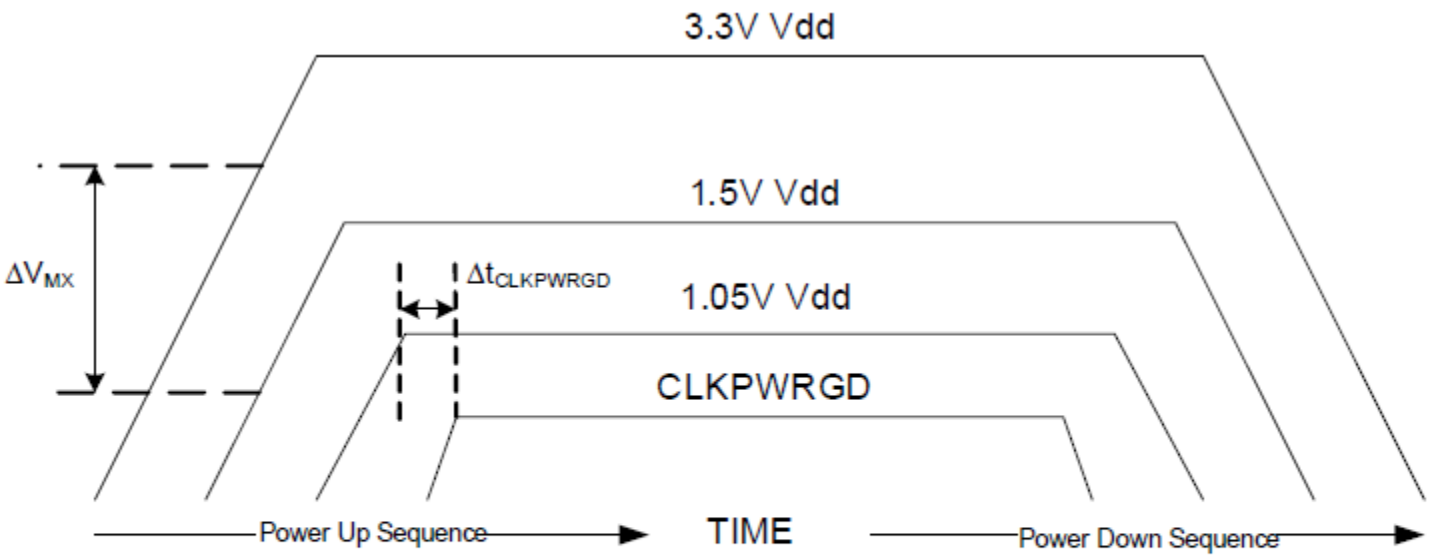
SSC OFF	Center Freq. MHz	Measurement Window							Units	Notes
		1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
		-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max		
CPU	100.00	9.91400		9.99900	10.00000	10.00100		10.08600	ns	1,2
	133.33	7.41425		7.49925	7.50000	7.50075		7.58575	ns	1,2
	166.67	5.91440		5.99940	6.00000	6.00060		6.08560	ns	1,2
	200.00	4.91450		4.99950	5.00000	5.00050		5.08550	ns	1,2
SRC	100.00	9.87400		9.99900	10.00000	10.00100		10.12600	ns	1,2
SATA	100.00	9.87400		9.99900	10.00000	10.00100		10.12600	ns	1,2
DOT96	96.00	10.16563		10.41563	10.41667	10.41771		10.66771	ns	1,2

Clock Periods–Differential Outputs with Spread Spectrum Enabled

SSC ON	Center Freq. MHz	Measurement Window							Units	Notes
		1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
		-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max		
CPU	99.75	9.91406	9.99906	10.02406	10.02506	10.02607	10.05107	10.13607	ns	1,2
	133.00	7.41430	7.49930	7.51805	7.51880	7.51955	7.53830	7.62330	ns	1,2
	166.25	5.91444	5.99944	6.01444	6.01504	6.01564	6.03064	6.11564	ns	1,2
	199.50	4.91453	4.99953	5.01203	5.01253	5.01303	5.02553	5.11053	ns	1,2
SRC	99.75	9.87406	9.99906	10.02406	10.02506	10.02607	10.05107	10.17607	ns	1,2
SATA	99.75	9.87406	9.99906	10.02406	10.02506	10.02607	10.05107	10.17607	ns	1,2

[1]Guaranteed by design and characterization, not 100% tested in production.
[2] All Long Term Accuracy specifications are guaranteed with the assumption that the crystal input is tuned to exactly 25.000000MHz.

Power-up Sequencing Requirements



Notes:

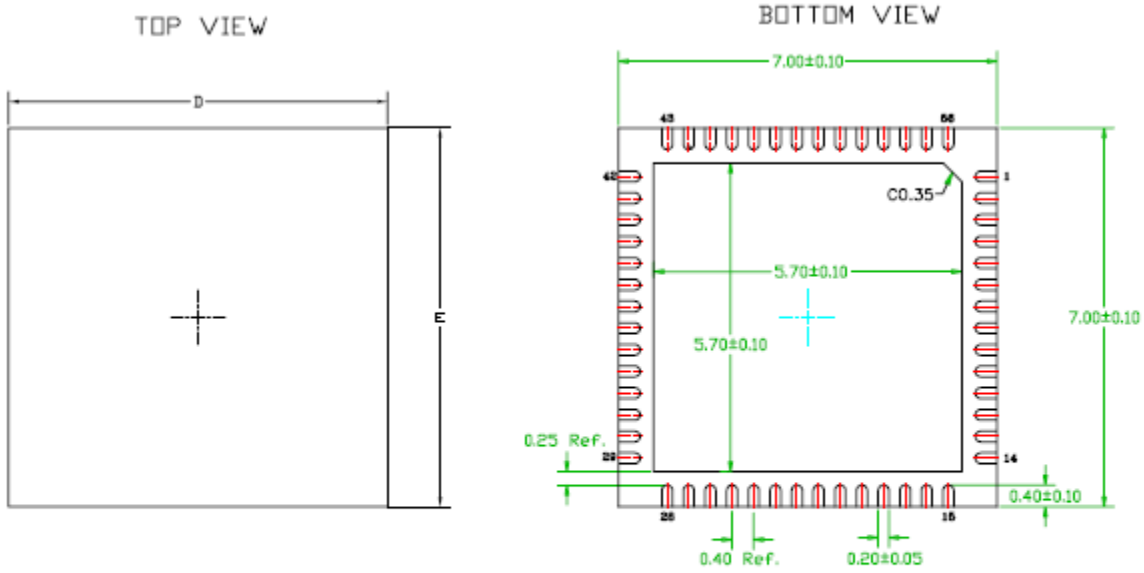
1. The maximum difference (ΔV_{MX}) between any two voltages is 0.7V if the lower power supply is powered up first.
2. There are no timing requirements between the higher and lower voltages if the higher voltages power up first.
3. The minimum time before CLKPWRGD can be set ($\Delta t_{CLKPWRGD} = 0$) is 0 sec from the last power supply that is powered up.

Marking Diagram

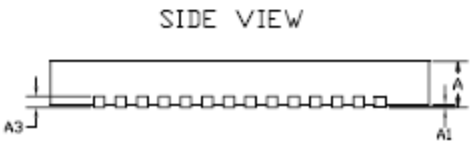
Notes:

1. ###### is the lot number.
2. YYWW is the last two digits of the year and week that the part was assembled.
3. “L” denotes RoHS compliant package.
4. “ORIGIN” is the country of origin.

Package Outline and Package Dimensions (56-pin MLF)



	Millimeters	
Symbol	**Min**	**Max**
A	0.8	1.0
A1	0	0.05
A3	0.2 Reference	
b	0.15	0.25
e	0.40 BASIC	
D x E BASIC	7.00 x 7.00	
D2 MIN./MAX.	5.60	5.80
E2 MIN./MAX.	5.60	5.80
L MIN./MAX.	0.30	0.50
N	56	
N_D	14	
N_E	14	



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
9VRS4339BKLF	see page 18	Trays	56-pin MLF	0 to +70° C
9VRS4339BKLFT		Tape and Reel	56-pin MLF	0 to +70° C

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

“B” is the device revision designator (will not correlate with the datasheet revision).

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Revision History

Rev.	Initiator	Issue Date	Description	Page #
0.1	DC	4/25/2011	Initial Release	-
0.2	DC	10/11/2011	1. Updated "Features/Benefits" section 2. Updated Power Distribution table 3. Updated Byte 13 4. Updated pin 55 description	Various
A	DC	1/3/2012	1. Updated "General Description" 2. Updated "Features/Benefits" 3. Updated pin descriptions 4. Updated Byte13 5. Updated "Absolute Max Ratings" and "Electrical Characteristics - Input/Supply/Common Output DC Parameters" tables	Various

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan

www.renesas.com

Contact Information

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